

**Amendments to the Translated Specification:**

Page 1, change line 1 as follows:

~~Description;~~

change the title in line 5 as follows:

~~Method for alignment and for exposure of a  
semiconductor wafer~~

METHOD FOR ALIGNING AND EXPOSING A SEMICONDUCTOR  
WAFER;

above the first paragraph and below the title,  
insert

-- Background of the Invention:

Field of the Invention: --.

Page 4, between lines 3 and 5, insert

-- Summary of the Invention: --.

Page 10, between lines 16 and 18

-- Brief Description of the Drawings: --;

between lines 31 and 33, insert

-- Description of the Preferred Embodiments: --.

Page 16, change line 1 as follows:

~~Patent claims:~~ We claim:.

Page 20, change line 1 as follows:

~~Abstract~~ Abstract of the Disclosure:;

change line 22 as follows:

~~Figure 3.~~